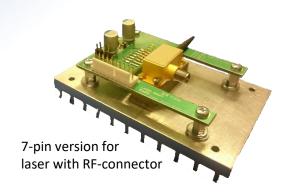
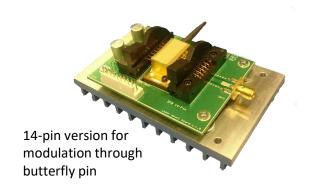


MLM Series

Mounts for directly modulated lasers

Lasers not included





MLM Series mounts for directly modulated butterfly-package lasers are a convenient heat-sinked package for OEM or lab use. The mounts come in two varieties: a 14-pin butterfly package modulated though one of the pins, or a butterfly package with 7-pins and an RF-connector for modulation. Both varieties can have either direct soldering for permanent laser installation or a socket holder for simple interchanging of lasers.

KEY FEATURES

- 14-pin butterfly package for 2.5 Gb/s modulation
- 7-pin butterfly package with RF-connector
- Direct solder or socket holder
- Bias current noise filtering
- Heatsink



MLM Series

Mounts for directly modulated lasers

14-pin butterfly package pinout

Pin #	Configuration
1	Thermistor (+)
2	Thermistor (-)
3	Laser Cathode
4	Photodiode Anode
5	Photodiode Cathode
6	TEC (+)
7	TEC (-)
8	Case ground
9	Case ground
10	Case ground
11	Laser Anode
12	RF modulation input (Laser Cathode)
13	Laser Anode
14	Case ground

7-pin butterfly package pinout

Pin#	Configuration
1	Thermistor (+)
2	Thermistor (-)
3	Laser Cathode
4	Photodiode Anode
5	Photodiode Cathode
6	TEC (+)
7	TEC (-)
RF	RF modulation input (Laser Cathode)
Package	Laser Anode

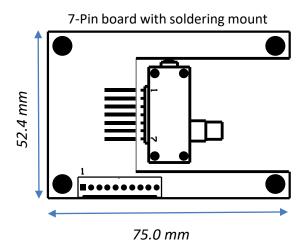
Molex connector pinout on PCB

Pin #	Configuration
1	Laser Cathode
2	Photodiode Anode
3	Photodiode Cathode
4	Laser Anode
5	N/C
6	TEC (+)
7	TEC (-)
8	Thermistor (+)
9	Thermistor (-+)
10	N/C

Heatsink size: 106.2 mm x 63.5 mm

14-Pin board with socket mount

75.0 mm



RAM PHOTONICS, LLC